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TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK3130

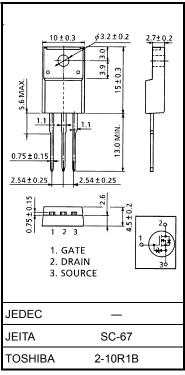
Switching Regulator Applications

• Reverse-recovery time: t_{rr} = 85 ns

- Built-in high-speed flywheel diode
- Low drain-source ON resistance: $RDS(ON) = 1.12 \Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 5.0 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 100 \ \mu A (max) (V_{DS} = 600 \ V)$
- Enhancement model: $V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, \text{I}_{D} = 1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	Rating	Unit	
Drain-source voltage			V _{DSS}	600	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)			V _{DGR}	600	V	
Gate-source voltage			V _{GSS}	±30	V	
Drain current	DC (Note	1)	۱ _D	6	А	
	Pulse (Note	1)	I _{DP}	24	Ā	
Drain power dissipation (Tc = 25° C)			PD	40	W	
Single pulse avalanche energy (Note 2)			E _{AS}	345	mJ	
Avalanche current			I _{AR}	6	А	
Repetitive avalanche energy (Note 3)			E _{AR}	4	mJ	
Channel temperature			T _{ch}	150	°C	
Storage temperature range			T _{stg}	-55~150	°C	



Weight: 1.9 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.125	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} =$ 90 V, $T_{ch} =$ 25°C (initial), L = 16.8 mH, $R_G =$ 25 Ω , $I_{AR} =$ 6 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature.

This transistor is an electrostatic-sensitive device. Please handle with caution

Unit: mm

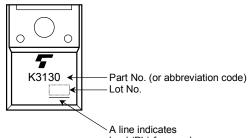
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS} = \pm 25 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	_	_	±10	μA
Gate-source breakdown voltage		V (BR) GSS	$I_G=\pm 100~\mu A,~V_{DS}=0~V$	±30	_	_	V
Drain cut-OFF cu	irrent	I _{DSS}	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			100	μA
Drain-source bre	ain-source breakdown voltage V		$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	600	_		V
Gate threshold voltage		V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	2.0	_	4.0	V
Drain-source ON resistance		R _{DS (ON)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$	_	1.12	1.55	Ω
Forward transfer admittance		Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$	1.5	5.0	_	S
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	1300	_	pF
Reverse transfer capacitance		C _{rss}			130		
Output capacitance		C _{oss}			400		
Switching time	Rise time	tr	$U_{GS} = 3 A \qquad V_{OUT}$ $U_{GS} = 0 V \qquad U_{GS} = 100 \Omega$ $C_{I} = 0 V \qquad V_{DD} \simeq 300 V$ $Duty \le 1\%, t_{W} = 10 \mu s$		25		ns
	Turn-ON time	t _{on}			45		
	Fall time	t _f			40		
	Turn-OFF time	t _{off}		_	150		
Total gate charge (gate-source plus	al gate charge te-source plus gate-drain) Qg				30		nC
Gate-source charge		Q _{gs}	$V_{DD} \simeq 400 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 6 \text{ A}$	_	18	_	
Gate-drain ("miller") charge		Q _{gd}		_	12	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

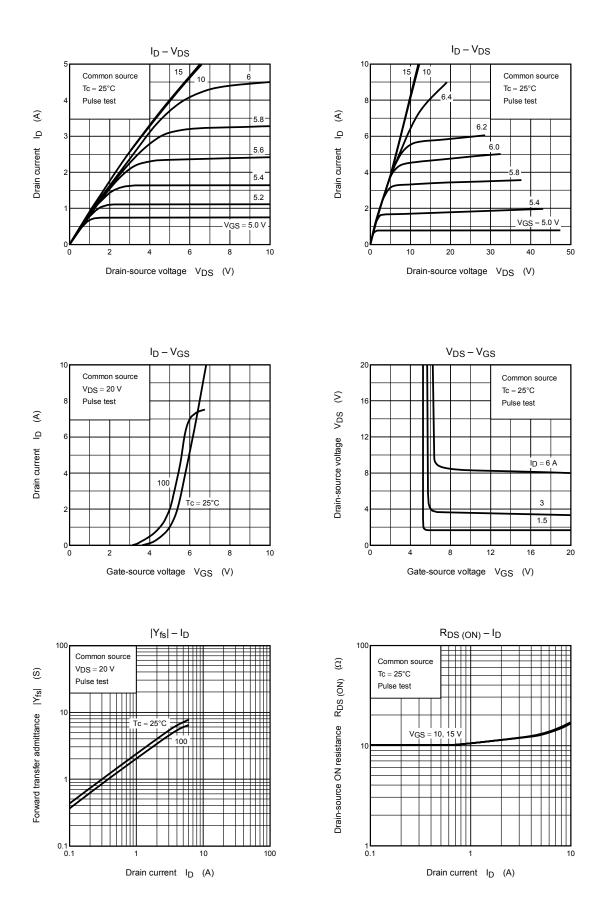
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_	_	6	А
Pulse drain reverse current (Note 1)	I _{DRP}	—	_	_	24	А
Forward voltage (diode)	V _{DSF}	$I_{DR} = 6 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.7	V
Reverse recovery time	t _{rr}	$I_{DR} = 6 \text{ A}, V_{GS} = 0 \text{ V},$	_	85	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 100 A/μs		0.21		μC

Marking

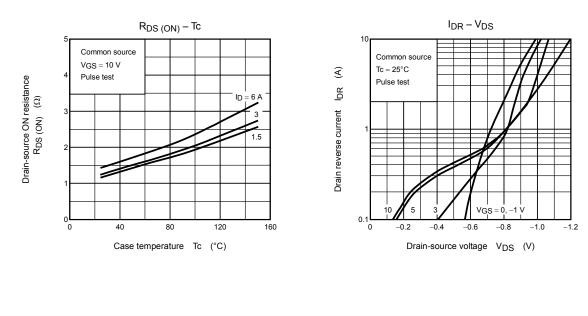


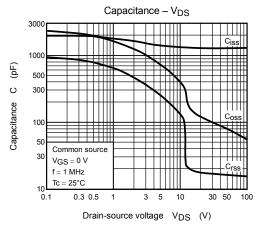
lead (Pb)-free package or lead (Pb)-free finish.

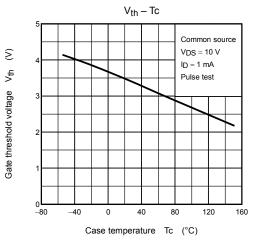
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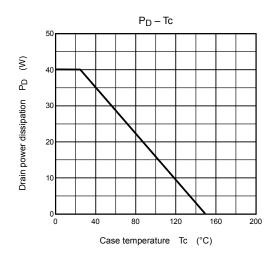


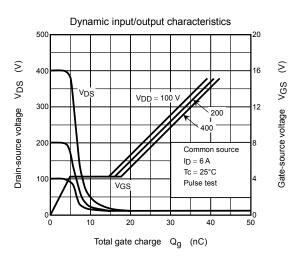
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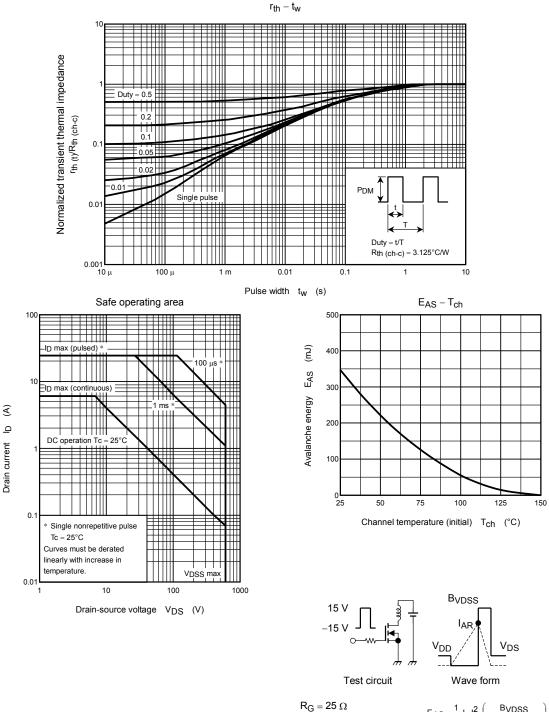












 $\begin{array}{l} \mathsf{R}_{G} = 25 \; \Omega \\ \mathsf{V}_{DD} = 90 \; \mathsf{V}, \; \mathsf{L} = 16.8 \; \mathsf{mH} \end{array} \quad \begin{array}{l} \mathsf{E}_{AS} = \frac{1}{2} \cdot \mathsf{L} \cdot \mathsf{I}^{2} \cdot \left(\frac{\mathsf{B}_{VDSS}}{\mathsf{B}_{VDSS} - \mathsf{V}_{DD}} \right) \end{array}$

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